STPS0530Z

life.augmented

Schottky rectifier

Datasheet - production data



Description

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SOD-123, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due to the small size of the package this device fits GSM and PCMCIA requirements.

Table 1. Device summary

I _{F(AV)}	0.5 A
V _{RRM}	30 V
V _F (max)	0.33 V

Features

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching

This is information on a product in full production.

1 Characteristics

Symbol	Parameter	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage	30	V		
I _{F(RMS)}	Forward rms current	2	А		
I _{F(AV)}	Average forward current $\delta = 0.5$	T _a = 55 °C	0.5	А	
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		5.5	А	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs		
T _{stg}	Storage temperature range	-65 to +150	°C		
Тj	Operating junction temperature range ⁽¹⁾	-40 to +150	°C		
ΤL	Maximum temperature for soldering dur	260	°C		
$\frac{dPtot}{dPtot} < 1$ condition to avoid thermal runaway for a diode on its own beatsink					

Table 2. Absolute ratings (limiting values)

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol Parameter	Value	Unit
R _{th(j-a)} Junction to ambient	340 ⁽¹⁾	°C/W

1. Copper area on PCB S = 2.5 mm^2

Symbol	Parameter	Test con	ditions	Тур.	Max.	Unit
		T _j = 25 °C	V _R = 15 V		12	μA
ı (1)	R ⁽¹⁾ Reverse leakage current	T _j = 125 °C		3	5	mA
'R`		T _j = 25 °C	V _R = V _{RRM}		130	μΑ
		T _j = 125 °C		9	21	mA
		T _j = 25 °C	I _F = 0.1 A		0.375	
V _F ⁽²⁾	Forward voltage drop	T _j = 125 °C		0.20	0.22	V
		T _j = 25 °C	I _F = 0.5 A		0.43	
		T _j = 125 °C		0.31	0.33	

Table 4. Static electrical characteristics

1. Pulse test: tp = 5 ms, δ < 2%

2. Pulse test: tp = 380 μ s, δ < 2%

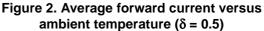
To evaluate the maximum conduction losses use the following equation:

 $P = 0.23 \text{ x } I_{F(AV)} + 0.18 I_{F}^{2}(RMS)$



current PF(AV)(W) 0.22 $-\delta = 0.1 - \delta = 0.2$ $\delta = 0.05$ δ 0.5 0.20 0.18 0.16 0.14 0.12 0.10 0.08 0.06 0.04 0.02 IF(AV)(A) ⊷tp δ=tp/T 0.00 0.0 0.1 0.2 0.3 0.4 0.5 0.6

Figure 1. Conduction losses versus average Fig



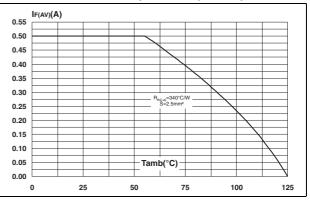


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

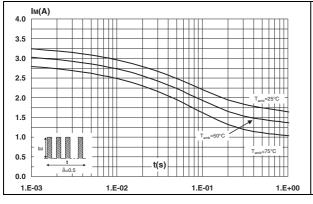


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration

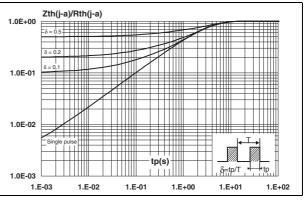


Figure 6. Reverse leakage current versus junction temperature (typical values)

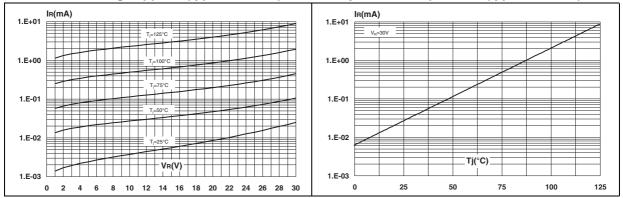
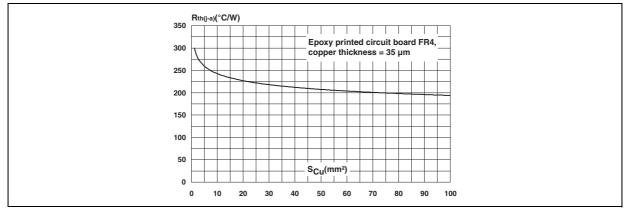




Figure 7. Junction capacitance versus reverse voltage applied (typical values) current C(pF) IFM(A) 1000 2.0 F=1MHz + 1.8 T_j=125°C 1.6 1.4 1.2 T_i=125°C 100 1.0 0.8 0.6 0.4 VR(V) 0.2 VFM(V) 10 0.0 1 10 100 0.00 0.10 0.20 0.30 0.40 0.50 0.60 0.70 0.80

Figure 8. Forward voltage drop versus forward

Figure 9. Thermal resistance junction to ambient versus copper surface under each lead (typical values)





2 Package information

- Epoxy meets UL94, V0.
- Band indicates cathode.

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

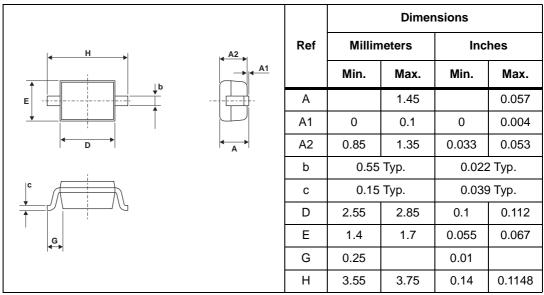
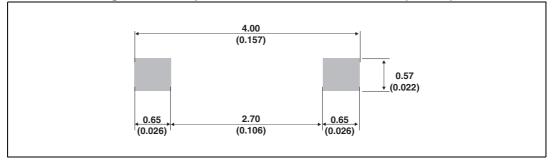


Table	5.	SOD-123	dimensions
-------	----	---------	------------

Figure 10. Footprint - dimensions in millimeters (inches)





3 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS0530Z	Z53	SOD-123	0.01 g	3000	Tape and reel

4 Revision history

Table 7. Document revision history	Table 7.	Document	revision	history
------------------------------------	----------	----------	----------	---------

Date	Revision	Changes
Mar-2003	1A	Initial release.
17-Oct-2006	2	Reformated to current standards. Updated maximum junction temperatures to 150 °C and updated package illustration to show cathode bar on page 1
23-Apr-2014	3	Updated Tj max to Tj range in <i>Table</i> 2.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2014 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID9383 Rev 3

AMEYA360 Components Supply Platform

Authorized Distribution Brand :



Website :

Welcome to visit www.ameya360.com

Contact Us :

> Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales :

- Direct +86 (21) 6401-6692
- Email amall@ameya360.com
- QQ 800077892
- Skype ameyasales1 ameyasales2

> Customer Service :

Email service@ameya360.com

> Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com